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(54) **METHODS AND ELECTROLYTES FOR
ELECTRODEPOSITION OF SMOOTH FILMS**

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Related U.S. Application Data

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H01M 4/04 (2006.01)
C09D 5/44 (2006.01)
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C25D 3/12 (2006.01)
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CPC **C25D 3/02** (2013.01); **C09D 5/4484**
(2013.01); **C25D 3/12** (2013.01); **C25D 3/20**
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(2013.01); **C25D 3/50** (2013.01); **C25D 5/00**
(2013.01); **C25D 13/22** (2013.01)

USPC **429/137**; 429/188; 429/50
(58) **Field of Classification Search**
USPC 429/50, 188, 137
See application file for complete search history.

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Primary Examiner — Stewart Fraser

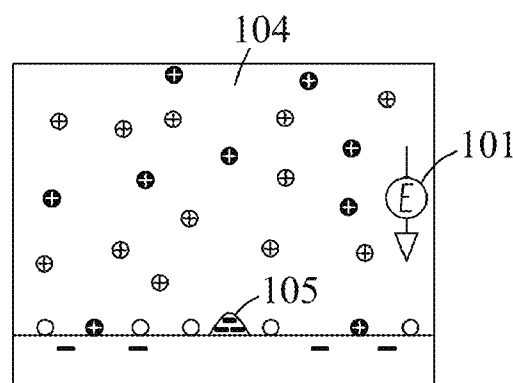
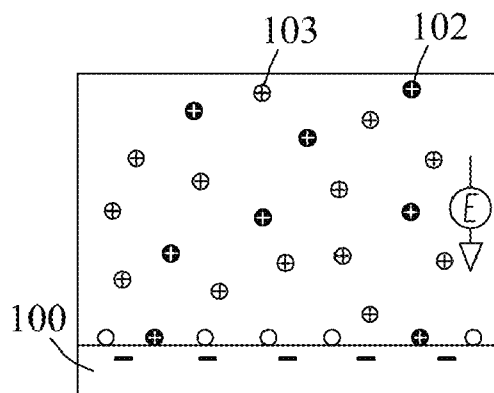
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(57) **ABSTRACT**

Electrodeposition involving an electrolyte having a surface-
smoothing additive can result in self-healing, instead of self-
amplification, of initial protuberant tips that give rise to
roughness and/or dendrite formation on the substrate and/or
film surface. For electrodeposition of a first conductive materi-
al (C1) on a substrate from one or more reactants in an
electrolyte solution, the electrolyte solution is characterized
by a surface-smoothing additive containing cations of a sec-
ond conductive material (C2), wherein cations of C2 have an
effective electrochemical reduction potential in the solution
lower than that of the reactants.

19 Claims, 5 Drawing Sheets



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C25D 3/48 (2006.01)
C25D 3/50 (2006.01)
C25D 5/00 (2006.01)
C25D 13/22 (2006.01)

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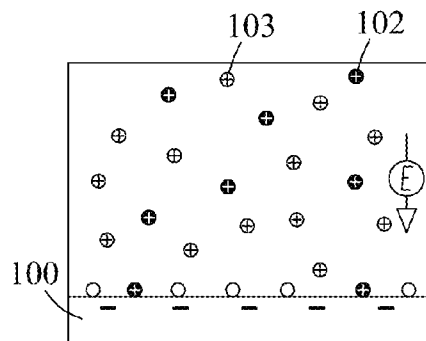


FIG. 1A

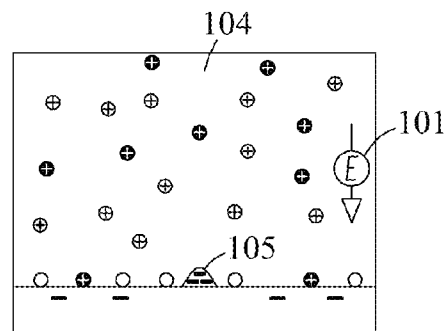


FIG. 1B

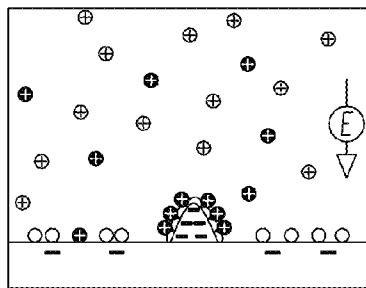


FIG. 1C

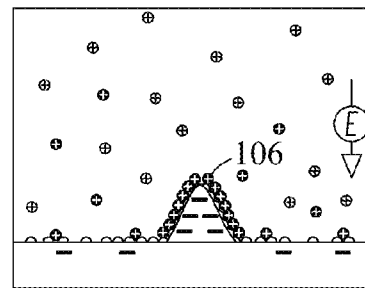


FIG. 1D

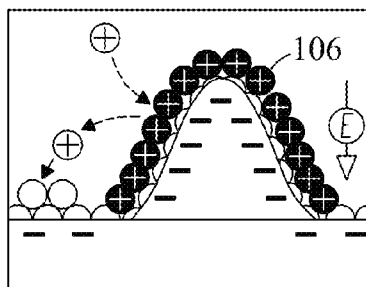


FIG. 1E

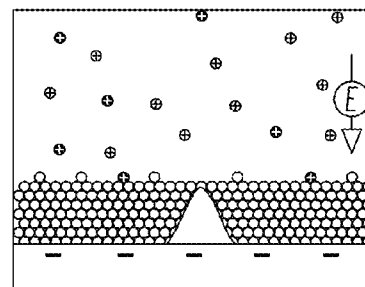


FIG. 1F

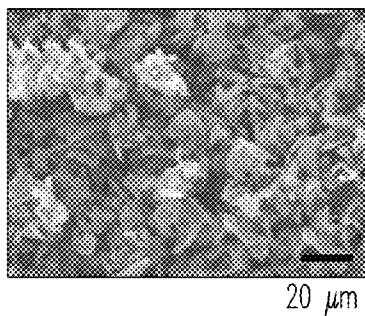


FIG. 2A

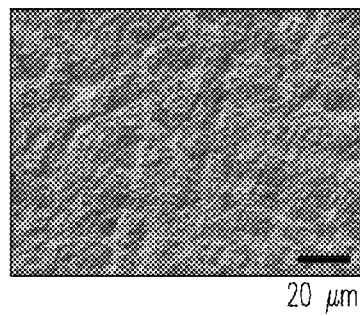


FIG. 2B

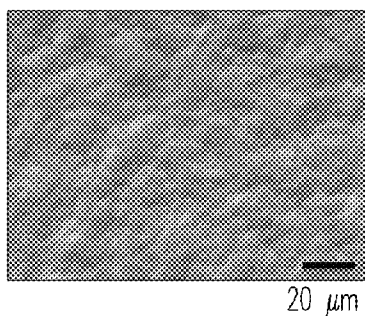


FIG. 2C

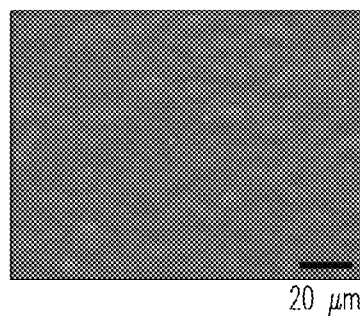


FIG. 2D

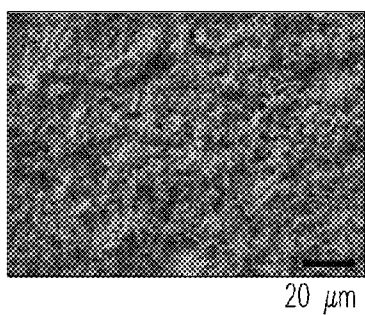


FIG. 3A

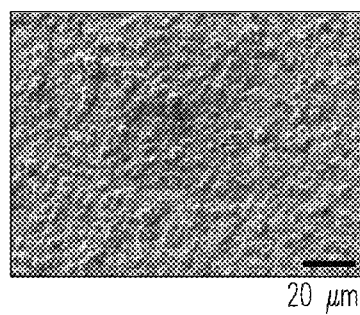


FIG. 3B

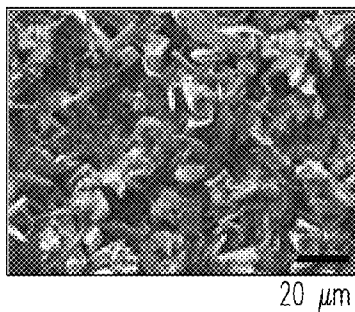


FIG. 4A

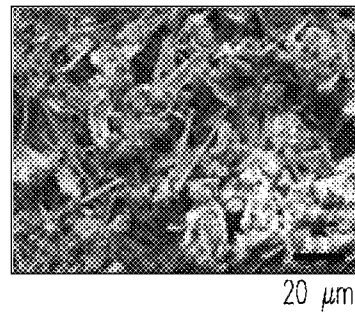


FIG. 4B

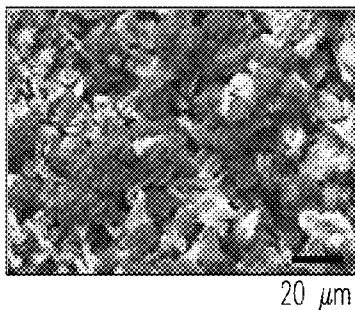


FIG. 4C

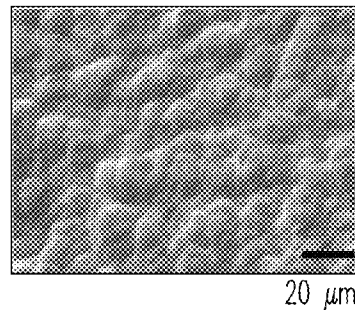


FIG. 4D

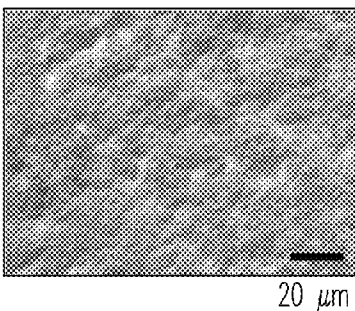


FIG. 4E

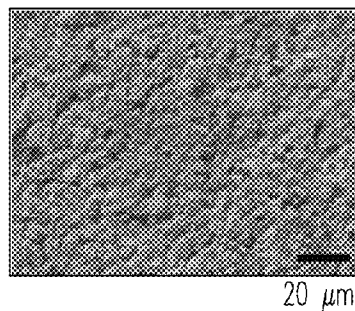


FIG. 4F

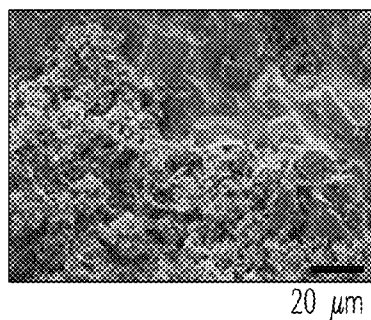


FIG. 5A

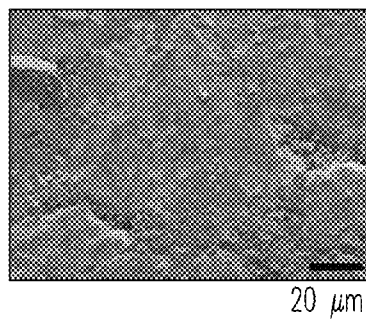


FIG. 5B

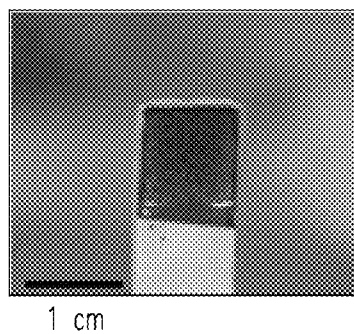


FIG. 6A

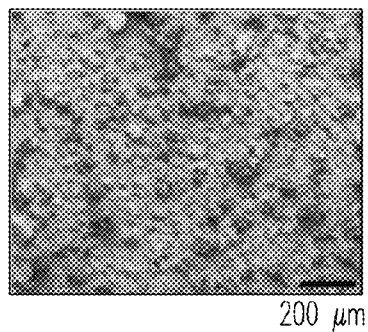


FIG. 6B

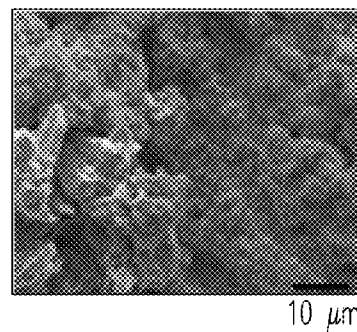


FIG. 6C

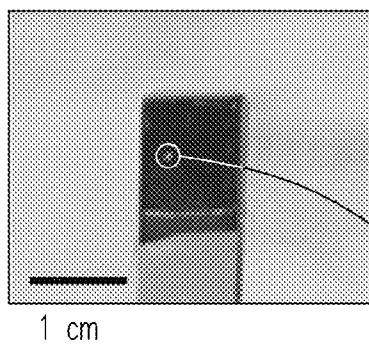


FIG. 6D

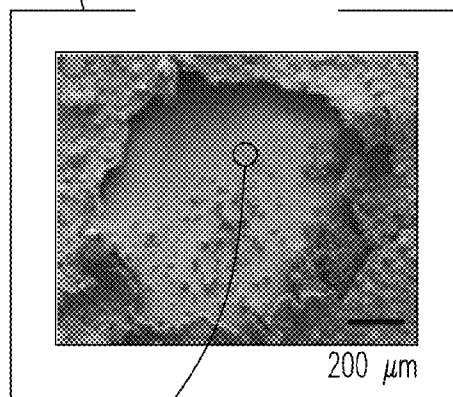


FIG. 6E

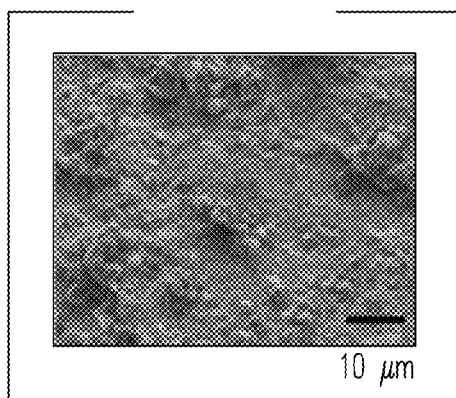


FIG. 6F

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METHODS AND ELECTROLYTES FOR ELECTRODEPOSITION OF SMOOTH FILMS

CROSS-REFERENCE TO RELATED APPLICATIONS

This invention claims priority from, and is a continuation in part of, currently pending U.S. patent application Ser. No. 13/367,508, filed Feb. 7, 2012, incorporated herein by reference.

STATEMENT REGARDING FEDERALLY SPONSORED RESEARCH OR DEVELOPMENT

This invention was made with Government support under Contract DE-AC0576RL01830 awarded by the U.S. Department of Energy. The Government has certain rights in the invention.

BACKGROUND

Electrodeposition is widely used to coat a functional material having a desired property onto a surface that otherwise lacks that property. During electrodeposition, electrically charged reactants in an electrolyte solution diffuse, or are moved by an electric field, to cover the surface of an electrode. For example, the electrical current can reduce reactant cations to yield a deposit on an anode. Or, anions of reactants in the electrolyte solution can diffuse, or be moved by the electric field, to cover the surface of a cathode, where the reactant anions are oxidized to form a deposit on the electrode.

Electrodeposition has been successfully utilized in the fields of abrasion and wear resistance, corrosion protection, lubricity, aesthetic qualities, etc. It also occurs in the operation of certain energy storage devices. For example, in the charge process of a metal battery or metal-ion battery, metal ions in the electrolyte move from the cathode and are deposited on the anode. Some organic compounds with unsaturated carbon-carbon double or triple bonds are used as additives in non-aqueous electrolytes and are electrochemically reduced and deposited at the anode surface or oxidized and deposited at the cathode surface to form solid electrolyte interphase layers as protection films on both anode and cathode of lithium batteries. Some other organic compounds with conjugated bonds in the molecules are electrochemically oxidized and deposited at the cathode surface to form electrically conductive polymers as organic cathode materials for energy storage devices.

In most instances, the ideal is a smooth electrodeposited coating. For example, a smoothly plated film can enhance the lifetime of a film used for decoration, wear resistance, corrosion protection, and lubrication. A smoothly plated film is also required for energy storage devices, especially for secondary devices. Rough films and/or dendrites generated on electrode surfaces during the charge/discharge processes of these energy storage devices can lead to the dangerous situations, short-circuits, reduced capacities, and/or shortened lifetimes.

Roughness and/or dendrites can be caused by several reasons, including the uneven distribution of electric current density across the surface of the electrodeposition substrate (e.g., anode) and the uneven reactivity of electrodeposited material and/or substrate to electrolyte solvents, reactants, and salts. These effects can be compounded in the particular case of repeated charging-discharging cycles in energy storage devices. Therefore, a need for improved electrolytes and

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methods for electrodeposition are needed to enhance the smoothness of the resultant film.

SUMMARY

This document describes methods and electrolytes for electrodeposition that result in self-healing, instead of self-amplification, of initial protuberant tips, which are unavoidable during electrodeposition and which give rise to roughness and/or dendrite formation. For electrodeposition of a first conductive material (C1) on a substrate from one or more reactants in an electrolyte solution, embodiments of the electrolyte solution described herein are characterized by a soluble, surface-smoothing additive comprising cations of a second conductive material (C2), wherein cations of C2 have an effective electrochemical reduction potential (ERP) in the solution lower than that of the reactants.

As used herein, cations, in the context of C1, C2, and/or reactants, refer to atoms or molecules having a net positive electrical charge. In but one example, the total number of electrons in the atom or molecule can be less than the total number of protons, giving the atom or molecule a net positive electrical charge. The cations are not necessarily cations of metals, but can also be non-metallic cations. At least one example of a non-metallic cation is ammonium. Cations are not limited to the +1 oxidation state in any particular instance. In some descriptions herein, a cation can be generally represented as X^+ , which refers generally to any oxidation state, not just +1.

In another example, the reactants might not technically be cations but are positively charged species such as conductive monomers/polymers. During the electrodeposition of a metal cation, the cation gets the electron at the anode and is reduced to metal. When forming a conductive polymer via electrodeposition, it is the conjugated monomer, which can be neutral but with double or triple bonds, that gets the electrons. The conjugated monomer re-arranges the double or triple bonds among the same molecular structure and forms new bonds among different molecules. The formed polymer is either neutral or positively charged when protons are incorporated onto the polymer moiety.

In one embodiment, C1 is a metallic material and the reactants comprise cations of C1. Examples of suitable metallic materials include, but are not limited to, elemental metals or alloys containing Li, Na, K, Rb, Cs, Be, Mg, Ca, Sr, Ba, Al, Ga, In, Tl, Ge, Sn, Pb, As, Sb, Bi, Se, Te, Bi, Po, Sc, Ti, V, Cr, Mn, Fe, Co, Ni, Cu, Zn, Y, Zr, Nb, Mo, Tc, Ru, Rh, Pd, Ag, Cd, W, Pt, Au, and/or Hg. Preferably, C1 is an elemental metal material comprising Li, Zn, Na, Mg, Al, Sn, Ti, Fe, Ni, Cu, Zn, Ag, Pt, or Au.

Alternatively, C1 can comprise an electronic conductive polymer. In such instances, the reactants can comprise monomers of the polymer. The monomers can be conjugated monomers that are reduced at the anode during deposition. Examples of polymers can include, but are not limited to, polyaniline, polypyrrole, polythiophene, poly(3,4-ethylenedioxythiophene). Monomers of these polymers can include, but are not limited to, aniline, pyrrole, thiophene, 3,4-ethylenedioxythiophene, respectively.

In another embodiment, the cations of C2 are metal cations. Examples of metals for cations of C2 include, but are not limited to, Li, Cs, Rb, K, Ba, La, Sr, Ca, Ra, Zr, Te, B, Bi, Ta, Ga, Eu, S, Se, Nb, Na, Mg, Cu, Al, Fe, Zn, Ni, Ti, Sn, Sb, Mn, V, Ta, Cr, Au, Ge, Co, As, Ag, Mo, Si, W, Ru, I, Fc, Br, Re, Bi, Pt, and/or Pd. In preferred embodiments, cations of C2 are cations of Cs, Rb, K, Ba, Sr, Ca, Li.

A cation of C2 might have a standard reduction potential that is greater than that of the reactants. In such instances, some embodiments of the electrolytes have an activity of C2 cations such that the effective ERP of the C2 cations is lower than that of the reactants (C1). Because activity is directly proportional to the concentration and activity coefficient, which depend on the mobility and solvation of the cation in the given electrolyte, a lower activity can be a result of low concentration, low activity coefficient of the cations, or both since the activity is the product of the activity coefficient and concentration. The relationship between effective ERP and activity is described in part by the Nernst equation and is explained in further detail elsewhere herein. In a particular embodiment, the concentration of C2 cations is less than, or equal to, 30% of that of the reactants. In another, the concentration of C2 cations is less than, or equal to, 10% of that of the reactants. In yet another, the concentration of C2 cations is less than, or equal to, 5% of that of the reactants.

The surface-smoothing additive can comprise an anion that includes, but is not limited to, PF_6^- , AsF_6^- , BF_4^- , $\text{N}(\text{SO}_2\text{CF}_3)_2^-$, $\text{N}(\text{SO}_2\text{F})_2^-$, CF_3SO_3^- , ClO_4^- , I^- , Cl^- , OH^- , NO_3^- , SO_4^{2-} , and combinations thereof. Preferably, the anion comprises PF_6^- .

In one embodiment, the substrate is an electrode. For example, the substrate on which electrodeposition occurs can be an electrode in an energy storage device. In particular instances, the electrode can comprise lithium, carbon, magnesium, and/or sodium. As used herein, electrode is not restricted to a complete structure having both an active material and a current collector. For example, an electrode can initially encompass a current collector on which active material is eventually deposited to form an anode. Alternatively, an electrode can start out as an active material pasted on a current collector. After initial cycling, the active material can be driven into the current collector to yield what is traditionally referred to as an electrode.

Preferably, the cations of C2 are not chemically or electrochemically reactive with respect to C1 or the reactants. Accordingly, the surface-smoothing additive is not necessarily consumed during electrodeposition.

The electrolyte also comprises a solvent. Examples of solvents can include, but are not limited to, water or a non-aqueous polar organic substance that dissolves the solutes at room temperature. Blends of more than one solvent can be used. When water or a protic organic substance is used as the solvent, C1 is not a metal that reacts with water or the protic organic substance. Generally, organic solvents can include, but are not limited to, alcohols, ethers, aldehydes, ketones, carbonates, carboxylates, lactones, phosphates, nitriles, sulfones, amides, five or six member heterocyclic ring compounds, and organic compounds having at least one $\text{C}_1\text{-C}_4$ group connected through an oxygen atom to a carbon. Lactones may be methylated, ethylated and/or propylated. Other organic solvents can include methanol, ethanol, acetone, sulfolane, dimethyl sulfone, ethyl methyl sulfone, ethylene carbonate, propylene carbonate, dimethyl carbonate, diethyl carbonate, ethyl methyl carbonate, methyl propyl carbonate, tetrahydrofuran, 2-methyl tetrahydrofuran, 1,3-dioxolane, 1,4-dioxane, 1,2-dimethoxyethane, 1,2-diethoxyethane, 1,2-dibutoxyethane, acetonitrile, dimethylformamide, methyl formate, ethyl formate, propyl formate, butyl formate, methyl acetate, ethyl acetate, propyl acetate, butyl acetate, methyl propionate, ethyl propionate, propyl propionate, butyl propionate, methyl butyrate, ethyl butyrate, propyl butyrate, butyl butyrate, gamma-butyrolactone, 2-methyl-gamma-butyrolactone, 3-methyl-gamma-butyrolactone, 4-methyl-gamma-butyrolactone, delta-valerolactone, trimethyl phosphate, tri-

ethyl phosphate, tris(2,2,2-trifluoroethyl)phosphate, tripropyl phosphate, triisopropyl phosphate, tributyl phosphate, trihexyl phosphate, triphenyl phosphate, and combinations thereof. Still other non-aqueous solvents can be used so long as they are capable of dissolving the solute salts.

Methods for improving surface smoothness during electrodeposition of C1 on a substrate surface can comprise providing an electrolyte solution comprising reactants from which C1 is deposited and a soluble, surface-smoothing additive comprising cations of a second conductive material (C2) and applying an electrical potential thereby reducing the reactants and forming C1 on the substrate surface. The cations of C2 have an effective electrochemical reduction potential in the solution lower than that of the reactants. In preferred embodiments, the methods further comprise accumulating cations of C2 at protrusions on the substrate surface, thereby forming an electrostatically shielded region near each protrusion. The electrostatically shielded region can temporarily repel reactants, thus reducing the local effective current density and slowing deposition at the protrusion while enhancing deposition in regions away from the protrusions. In this way, the growth and/or amplification of the protrusions are suppressed and the surface heals to yield a relatively smoother surface.

In one embodiment, the method is applied to electrodeposition of lithium on a substrate surface. Lithium is an effective example because Li^+ ions have the lowest standard ERP among metals (at a concentration of 1 mol/L, a temperature of 298.15 K (25° C.), and a partial pressure of 101.325 kPa (absolute) (1 atm, 1.01325 bar) for each gaseous reagent). C2 cations, which have standard EPR values that are greater than lithium cations can have activity-dependent effective ERP values that are lower than those of the lithium cations.

According to such embodiments, the method comprises providing an electrolyte solution comprising lithium cations and a soluble, surface-smoothing additive comprising cations of a second conductive material (C2) selected from the group consisting of cesium, rubidium, potassium, strontium, barium, calcium, and combinations thereof. The cations of C2 have a concentration and activity coefficient in solution such that the effective electrochemical reduction potential of the cations of C2 is lower than that of the lithium cations. The method further comprises applying an electrical potential, thereby reducing the lithium cations and forming lithium on the substrate surface. The method further comprises accumulating cations of C2 at protrusions on the substrate surface, thereby forming an electrostatically shielded region near each protrusion and temporarily repelling the lithium cations from the electrostatically shielded regions. In some instances, the electrostatically shielded region has a higher impedance to retard the further deposition of lithium cations.

In particular embodiments, the concentration of C2 cations is less than, or equal to 30% of that of the lithium cations. In others, the C2 cation concentration is less than, or equal to, 5% of that of the lithium cations. Preferably, the surface-smoothing additive comprises an anion comprising PF_6^- anion. The substrate can be a battery anode that comprises lithium or that comprises carbon.

The purpose of the foregoing abstract is to enable the United States Patent and Trademark Office and the public generally, especially the scientists, engineers, and practitioners in the art who are not familiar with patent or legal terms or phraseology, to determine quickly from a cursory inspection the nature and essence of the technical disclosure of the application. The abstract is neither intended to define the

invention of the application, which is measured by the claims, nor is it intended to be limiting as to the scope of the invention in any way.

Various advantages and novel features of the present invention are described herein and will become further readily apparent to those skilled in this art from the following detailed description. In the preceding and following descriptions, the various embodiments, including the preferred embodiments, have been shown and described. Included herein is a description of the best mode contemplated for carrying out the invention. As will be realized, the invention is capable of modification in various respects without departing from the invention. Accordingly, the drawings and description of the preferred embodiments set forth hereafter are to be regarded as illustrative in nature, and not as restrictive.

DESCRIPTION OF DRAWINGS

Embodiments of the invention are described below with reference to the following accompanying drawings.

FIGS. 1A-1F are illustrations depicting an embodiment of electrodeposition using an electrolyte having a surface-smoothing additive.

FIGS. 2A-2D include SEM micrographs of Li films deposited in an electrolyte with or without a surface-smoothing additive according to embodiments of the present invention; (a) No additive; (b) 0.05 M RbPF₆; (c) 0.05 M CsPF₆; (d) 0.15 M KPF₆.

FIGS. 3A-3B include SEM micrographs of pre-formed dendritic Li film deposited in a control electrolyte for 1 hour and the same film after another 14 hours' Li deposition in the electrolyte with additive (0.05M CsPF₆), respectively.

FIGS. 4A-4F include SEM micrographs of Li electrodes after repeated deposition/stripping cycles in the control electrolytes (a, b, and c) and with Cs⁺-salt additive (d, e and f).

FIGS. 5A-5B include SEM micrographs of Li electrodes after 100 cycles in coin cells of Li/Li₄Ti₅O₁₂ containing electrolytes without (a) and with (b) 0.05 M Cs⁺ additive.

FIGS. 6A-6F include optical and SEM micrographs of hard carbon electrodes after charging to 300% of the regular capacity in the control electrolyte (a, c, e) and in an electrolyte with 0.05 M CsPF₆ additive added in the control electrolyte (b, d, f).

DETAILED DESCRIPTION

The following description includes the preferred best mode of one embodiment of the present invention. It will be clear from this description of the invention that the invention is not limited to these illustrated embodiments but that the invention also includes a variety of modifications and embodiments thereto. Therefore the present description should be seen as illustrative and not limiting. While the invention is susceptible of various modifications and alternative constructions, it should be understood, that there is no intention to limit the invention to the specific form disclosed, but, on the contrary, the invention is to cover all modifications, alternative constructions, and equivalents falling within the spirit and scope of the invention as defined in the claims.

FIGS. 1-6 show a variety of embodiments and aspects of the present invention. Referring first to FIG. 1, a series of illustrations depict an embodiment of electrodeposition using an electrolyte **104** having a surface-smoothing additive. The additive comprises cations of C2 **102**, which have an effective ERP lower than that of the reactants **103**. FIG. 1 illustrates how an electrostatically shielded region **106** can develop resulting in the self-healing of the unavoidable occurrence of

surface protrusions **105** that would normally form. During the initial stage of deposition, both the reactants and the cations of C2 are adsorbed on the substrate surface **100** (FIG. 1A) under an applied voltage (E_a) **101** slightly less than the reduction potential of the reactant (E_r) but larger than the additive reduction potential ($E_{C2/C2^+}$), that is, $E_r > E_a > E_{C2/C2^+}$. Reactants will be deposited to form C1 on the substrate and will unavoidably form some protuberance tips due to various fluctuations in the system (FIG. 1B). A sharp edge or protrusion on the electrode exhibits a stronger electrical field, which will attract more positively charged cations (including both C1 and C2). Therefore, more cations of C1 will be preferentially deposited around the tips rather than on other smooth regions. In conventional electrodeposition, amplification of this behavior will form the surface roughness and/or dendrites. However, according to embodiments of the present invention, the adsorbed additive cations ($C2^+$) have an effective ERP lower than E_a (FIG. 1C) and will not be deposited (i.e., electrochemically or chemically consumed, reacted, and/or permanently bound) on the tip. Instead, they will be temporarily electrostatically attracted to and accumulated in the vicinity of the tip to form an electrostatic shield (FIG. 1D). This positively charged shield will repel incoming reactants (e.g., like-charged species) at the protruded region and force them to be deposited in non-protrusion regions. The net effect is that reactants will be preferentially deposited in the smoother regions of the substrate (FIG. 1E) resulting in a smoother overall deposition surface (FIG. 1F). This process is persistently occurring and/or repeating during electrodeposition. The self-healing mechanism described herein resulting from embodiments of the present invention appears to disrupt the conventional roughness and/or dendrite amplification mechanism and leads to the deposition of a smooth film of C1 on the substrate.

The additive cation ($C2^+$) exhibits an effective ERP, E_{Red} , less than that of the cations ($C1^+$) of the reactants. In some instances, the standard ERP of the C2 cation will be less than that of the reactants. Surface-smoothing additives comprising such C2 species can be utilized with appropriate reactants with few limitations on concentration and activity coefficient. However, in some instances, the C2 cation will have a standard ERP that is greater than that of the reactants. The concentration and activity coefficient of the C2 cations can be controlled such that the effective ERP of the C2 cations is lower than that of the reactant cations. For example, if the reactant is a Li⁺ ion, which has the lowest standard ERP among metals, then the concentration and activity coefficient of C2 cations can be controlled such that the effective ERP is lower than that of the lithium cations.

According to the Nernst equation:

$$E_{Red} = E_{Red}^0 - \frac{RT}{zF} \ln \frac{\alpha_{Red}}{\alpha_{Ox}} \quad (1)$$

where R is the universal gas constant ($=8.314 \text{ 472 J K}^{-1} \text{ mol}^{-1}$), T is the absolute temperature (assume $T=25^\circ \text{ C.}$ in this work), α is the activity for the relevant species (α_{Red} is for the reductant and α_{Ox} is for the oxidant). $\alpha_x = \gamma_x c_x$, where γ_x and c_x are the activity coefficient and the concentration of species x. F is the Faraday constant ($9.648 \text{ 533 99} \times 10^4 \text{ C mol}^{-1}$), z is the number of moles of electrons transferred. Although Li⁺ ion has the lowest standard reduction potential, $E_{Red}(\text{Li}^+)$, among all the metals when measured at a standard conditions (1 mol/L), a cation (M^+) may have an effective reduction potential lower than those of lithium ion (Li^+) if M^+

has an activity α_x much lower than that of Li^+ . In the case of low concentration when the activity coefficient is unity, α can be simplified as concentration c_x , then Eq. (1) can be simplified as:

$$E_{\text{Red}} = E_{\text{Red}}^{\circ} - \frac{0.05916 \text{ V}}{z} \log_{10} \frac{1}{c_{\text{Ox}}} \quad (2)$$

Table 1 shows several the reduction potentials for several cations (vs. standard hydrogen electrode (SHE)) at various concentrations assuming that their activity coefficients, γ_x , equal one. When the concentration of Cs^+ , Rb^+ , and K^+ is 0.01M in an electrolyte, their effective ERPs are -3.144 V , -3.098 V and -3.049 V , respectively, which are less than those of Li^+ at 1M concentration (-3.040 V). As a result, in a mixed electrolyte where the additive (Cs^+ , Rb^+ , and K^+) concentration is much less than Li^+ concentration, these additives will not be deposited at the lithium deposition potential. In addition to a low concentration c_x , a very low activity coefficient γ_x (which is strongly affected by the solvation and mobility of the cations in the given solvent and lithium salt) may also reduce the activity of cations and lead to an effective reduction potential lower than that of the lithium ion (Li^+) as discussed below.

TABLE 1

The effective reduction potential of selected cations vs. SHE				
	Li^+	Cs^+	Rb^+	K^+
Stand reduction potential (1M)	-3.040 V	-3.026 V	-2.980 V	-2.931 V
Effective reduction potential at 0.05M*	—	-3.103 V	-3.06 V	-3.01 V
Effective reduction potential at 0.01M*	—	-3.144 V	-3.098 V	-3.049 V

*Assume the activity coefficient γ_x of species x equals 1.

Surface Smoothing Exhibited in Electrodeposition of Lithium

Embodiments of the present invention are illustrated well in the electrodeposition of lithium, since lithium ions have the lowest standard ERP among metals. However, the present invention is not limited to lithium but is defined by the claims.

The effect of several C2 cations has been examined for use in surface-smoothing additives in the electrodeposition of lithium. The cations all have standard ERP values, E_{Red}° , that are close to that of Li^+ ions. The electrolyte comprised 1M LiPF_6 in propylene carbonate. Electrolyte solutions with surface-smoothing additives comprising 0.05 M RbPF_6 , 0.5 M CsPF_6 , or 0.15 M KPF_6 were compared to a control electrolyte with no additives. CsPF_6 , RbPF_6 , and $\text{Sr}(\text{PF}_6)_2$ were synthesized by mixing stoichiometric amount of AgPF_6 and the iodide salts of Cs, Rb, or Sr in a PC solution inside a glove box filled with purified argon where the oxygen and moisture content was less than 1 ppm. The formed AgI was filtered out from the solution using 0.45 μm syringe filters. The electrolyte preparation and lithium deposition were conducted inside the glove box as well. Lithium films were deposited on copper (Cu) foil substrates (10 mm \times 10 mm) in different electrolyte solutions at the desired current densities using a SOLARTRON® electrochemical Interface. After deposition, the electrode was washed with DMC to remove the residual electrolyte solvent and salt before the analyses.

Referring to the scanning electron microscope (SEM) micrograph in FIG. 2A, when using the control electrolyte,

the electrodeposited film exhibited conventional roughness and dendrite growth. The lithium film deposited in the electrolyte with 0.05 M Rb^+ as the C2 cation exhibits a very fine surface morphology without dendrite formation as shown in FIG. 2B. Similarly, for the lithium films deposited with 0.05 M Cs^+ additive, a dramatic change of the lithium morphology with no dendrite formation (see FIG. 2C) was obtained compared with the control experiment. Surprisingly, although $E_{\text{Red}}^{\circ}(\text{K}^+)$ at 0.15 M is theoretically $\sim 0.06 \text{ V}$ higher than that of Li^+ assuming both K^+ and Li^+ have an activity coefficient of 1, K metal did not deposit at the lithium deposition potential, and a lithium film with a mirror-like morphology was obtained using K^+ as in the additive (FIG. 2D). This experimental finding suggests that the activity coefficient γ_x for K^+ ion's in this electrolyte is much less than those of Li^+ leading to an actual $E_{\text{Red}}(\text{K}^+)$ lower than $E_{\text{Red}}(\text{Li}^+)$.

Generally, the concentration of the surface-smoothing additive is preferably high enough that protrusions can be effectively electrostatically shielded considering the effective ERP, the number of available C2 cations, and the mobility of the C2 cations. For example, in one embodiment, wherein the C2 cation comprises K^+ , the reactant comprises Li^+ and C1 comprises lithium metal, the concentration of K^+ is greater than 0.05M.

Referring to FIG. 3A, a dendritic lithium film was intentionally deposited on a copper substrate in a control electrolyte for 1 hour. The substrate and film was then transferred into an electrolyte comprising a surface-smoothing additive, 0.05 M CsPF_6 in 1 M LiPF_6/PC , to continue deposition for another 14 hours. Unlike the dendritic and mossy film deposited in the control electrolyte, the micrograph in FIG. 3B shows that a smooth lithium film was obtained after additional electrodeposition using embodiments of the present invention. The roughness, pits, and valleys shown in FIG. 3A have been filled by dense lithium deposits. The original needle-like dendritic whiskers have been converted to much smaller spherical particles which will also be buried if more lithium is deposited.

FIG. 4 includes SEM micrographs comparing the morphologies of the lithium electrodes after repeated deposition/stripping cycles (2nd, 3rd and 10th cycle) in cells using the control electrolyte (see FIGS. 4A, 4B, and 4C) and using electrolyte with a surface-smoothing additive comprising 0.05M Cs^+ (see FIGS. 4D, 4E, and 4F). The large lithium dendrites and dark lithium particles are clearly observed on the lithium films deposited in the control electrolyte. In contrast, the morphologies of the lithium films deposited in the Cs^+ -containing electrolyte still retain their dendrite free morphologies after repeated cycles. In all the films deposited with the additives, lithium films exhibit small spherical particles and smoother surfaces. This is in strong contrast with the needle-like dendrites grown in the control electrolyte.

Electrolytes and methods described herein were also applied in rechargeable lithium metal batteries. Coin cells with $\text{LiLi}_4\text{Ti}_5\text{O}_{12}$ electrodes were assembled using the control electrolyte. Similar cells were also assembled with electrolytes containing a surface smoothing additive comprising 0.05 M Cs^+ . FIG. 5 contains SEM micrographs showing the morphologies of the lithium metal anodes after 100 charge/discharge cycles. Referring to FIG. 5A, the lithium electrode in the cell with no additive exhibits clear surface roughness and formation of dendrites. However, as shown in FIG. 5B, no dendritic lithium was observed on the lithium electrode in the cell with the surface-smoothing additive, even after 100 cycles.

Surface-smoothing additives comprising higher valence cations can also be used. Examples include, but are not lim-

ited to, Sr^{2+} , which have E_{Red}^{Φ} values of -2.958 V (assuming $\gamma=1$) versus a standard hydrogen potential. The lower activity of these cations can result in an effective ERP lower than that of Li^+ ions. The larger size and higher charge should be accounted for in the non-aqueous electrolyte. Lithium films were deposited using the control electrolyte along with electrolytes comprising $0.05 \text{ M Sr}(\text{PF}_6)_2$. Deposition from the electrolyte comprising 0.05 M Sr^{2+} results in a lithium film that is smooth, free of dendrites, and void of Sr in/on the anode. This again indicates that the activity coefficient for Sr^{2+} in these solutions is less than unity.

Using this approach, C2 cations of the surface-smoothing additive are not reduced and deposited on the substrate. The C2 cations are not consumed because these cations exhibit an effective reduction potential lower than that of the reactant. In contrast, traditional electrodeposition can utilize additives having a reduction potential higher than that of the reactants; therefore, they will be reduced during the deposition process and "sacrificed or consumed," for example, as part of an SEI film or as an alloy to suppress dendrite growth. As a result, the additive concentration in the electrolyte will decrease with increasing charge/discharge cycles and the effect of the additives will quickly degrade. In contrast, the C2 cations described herein will form a temporary electrostatic shield or "cloud" around the dendritic tips that retards further deposition of C1 in this region. This "cloud" will form whenever a protrusion is initiated, but it will dissipate once applied voltage is removed or the protrusion is eliminated. Accordingly, in some embodiments, the applied electrical potential is of a value that is less than, or equal to, the ERP of the reactants and greater than the effective ERP of the cations of C2.

Lithium films having an SEI layer on the surface and deposited using electrolytes comprising 0.05 M Cs^+ , Rb^+ , K^+ , or Sr^{2+} additives were analyzed by x-ray photoelectron spectroscopy (XPS), Energy-dispersive X-ray spectroscopy (EDX) dot mapping, and Inductively coupled plasma atomic emission spectroscopy (ICP/AES) methods. XPS and EDX results did not show Cs, Rb, K, and Sr elements in the SEI films within the detectable limits of the analysis instruments. In addition, ICP-AES analysis did not identify Cs, Rb, K, and Sr elements in the bulk of deposited lithium film (including the SEI layer on the surface) within detectable limits.

Dendrite formation is not only a critical issue in rechargeable lithium metal batteries, but also an important issue in high power lithium ion batteries because lithium metal dendrites can grow at the anode surface when the lithium ions cannot move quickly enough to intercalate into the anode, which can comprise graphite or hard carbon, during rapid charging. In this case, the lithium dendrites can lead to short circuits and thermal runaway of the battery. Accordingly, a carbonaceous anode is described herein to demonstrate suppression of lithium dendrite growth in a lithium ion battery. FIG. 6 compares the optical (6A and 6D) and SEM images (6B, 6C, 6E, and 6F) of lithium particles formed on the hard carbon anode after it was charged to 300% of its theoretical capacity in a control electrolyte (without additives) and in an electrolyte having a surface smoothing additive comprising 0.05 M CsPF_6 . A significant amount of lithium metal was deposited on the surface of carbon electrode (see grey spots in FIG. 6A) for the sample overcharged in the control electrolyte. FIGS. 6B and 6C show clear dendritic growth on the electrode surface. In contrast, no lithium metal deposition was observed on the surface of carbon electrode (see FIG. 6D) for the sample overcharged in the electrolyte with 0.05 M Cs^+ additive (the white line on the bottom of the carbon sample is due to an optical reflection). After removing a small piece of carbon from the sample (see the circled area in FIG. 6D), it

was found that excess lithium was preferentially grown on the bottom of the carbon electrode as shown in FIGS. 6E and 6F.

While a number of embodiments of the present invention have been shown and described, it will be apparent to those skilled in the art that many changes and modifications may be made without departing from the invention in its broader aspects. The appended claims, therefore, are intended to cover all such changes and modifications as they fall within the true spirit and scope of the invention.

We claim:

1. A method for improving surface smoothness during electrodeposition of a first conductive material (C1) on a substrate surface, the method comprising:

providing an electrolyte solution comprising reactants from which C1 is synthesized and a soluble, surface-smoothing additive comprising cations of a second conductive material (C2), wherein cations of C2 have a) a standard electrical reduction potential that is greater than an electrochemical reduction potential of the reactants and (b) an activity in solution such that an effective electrochemical reduction potential of the cations of C2 in the solution is lower than the electrochemical reduction potential of the reactants; and

applying an electrical potential that is less than the electrochemical reduction potential of the reactants and greater than the effective electrochemical reduction potential of the cations of C2, thereby reducing the reactants and forming C1 on the substrate surface.

2. The method of claim 1, further comprising:

accumulating cations of C2 at protrusions on the substrate surface, thereby forming an electrostatically shielded region near each protrusion; and temporarily repelling reactants from the electrostatically shielded region near each protrusion.

3. The method of claim 1, wherein C1 is a metallic material and the reactants comprise cations of C1.

4. The method of claim 3, wherein C1 is selected from a group consisting of Na, K, Rb, Cs, Be, Mg, Ca, Sr, Ba, Al, Ga, In, Tl, Ge, Sn, Pb, As, Sb, Bi, Se, Te, Bi, Po, Sc, Ti, V, Cr, Mn, Fe, Co, Ni, Cu, Zn, Y, Zr, Nb, Mo, Tc, Ru, Rh, Pd, Ag, Cd, W, Pt, Au, Hg, and combinations thereof.

5. The method of claim 3, wherein C1 comprises Li.

6. The method of claim 1, wherein C1 comprises an electronic conductive polymer and the reactants comprise monomers of the polymer.

7. The method of claim 1, wherein the cations of C2 are metal cations.

8. The method of claim 7, wherein the cations of C2 comprise a metal selected from a group consisting of Li, Cs, Rb, K, Ba, La, Sr, Ca, Ra, Zr, Te, B, Bi, Ta, Ga, Eu, S, Se, Nb, Na, Mg, Cu, Al, Fe, Zn, Ni, Ti, Sn, Sb, Mn, V, Ta, Cr, Au, Ge, Co, As, Ag, Mo, Si, W, Ru, I, Fc, Br, Re, Bi, Pt, Pd, and combinations thereof.

9. The method of claim 1, wherein the cations of C2 have a concentration in the electrolyte solution that is less than 10% of that of the reactants.

10. The method of claim 1, wherein the concentration of the cations of C2 have a concentration in the electrolyte solution that is less than, or equal to, 5% of that of the reactants.

11. The method of claim 1, wherein the surface-smoothing additive comprises an anion selected from a group consisting of PF_6^- , AsF_6^- , BF_4^- , $\text{N}(\text{SO}_2\text{CF}_3)_2^-$, $\text{N}(\text{SO}_2\text{F})_2^-$, CF_3SO_3^- , ClO_4^- , I^- , Cl^- , OH^- , NO_3^- , SO_4^{2-} , and combinations thereof.

12. The method of claim 1, wherein the substrate is an electrode.

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13. The method of claim 12, wherein the electrode comprises lithium.

14. The method of claim 12, wherein the electrode comprises carbon.

15. A method for improving surface smoothness during electrodeposition of lithium on a substrate surface, the method comprising:

providing an electrolyte solution comprising lithium cations and a soluble, surface-smoothing additive comprising cations of a second conductive material (C2) selected from a group consisting of cesium, rubidium, potassium, strontium, barium, calcium, and combinations thereof, wherein cations of C2 have an activity in solution such that an effective electrochemical reduction potential of the cations of C2 is lower than an electrochemical reduction potential of the lithium cations; applying an electrical potential that is less than the electrochemical reduction potential of the lithium cations and greater than the effective electrochemical reduction

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potential of the cations of C2, thereby reducing the lithium cations and forming lithium on the substrate surface;

accumulation cations of C2 at protrusions on the substrate surface, thereby forming an electrostatically shielded region near each protrusion; and

temporarily repelling the lithium cations from the electrostatically shielded region near each protrusion.

16. The method of claim 15, wherein the cations of C2 have a concentration in the electrolyte solution that is less than 10% of that of the lithium cations.

17. The method of claim 15, wherein the cations of C2 have a concentration in the electrolyte solution that is less than, or equal to, 5% of that of the lithium cations.

18. The method of claim 15, wherein the surface-smoothing additive comprises an anion comprising PF_6^- anion.

19. The method of claim 15, wherein the substrate is a battery anode comprising lithium or a battery anode comprising carbon.

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